

LINEAR TECHNOLOGY MATERIALS DECLARATION

(Engineering Calculation)

MSOP-Exposed

LT3756HMSE-2#TRPBF

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TOTAL MASS (g): 0.035919

COMPONENT MATERIAL	VENDOR/INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL Pkg.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001292	1000000	3590.7929688		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.013845	975000	385450.34375		
		Iron (Fe)	7439-89-6	0.000341	24000	9491.57617188		
		Phosphorus (P)	7723-14-0	0.000004	300	111.361595154		
		Zinc (Zn)	7440-66-6	0.000010	700	278.403991699		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-99-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		<b>Lead Frame Total:</b>				<b>0.014290</b>	<b>1000000</b>	<b>395333.6875</b>
		Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0
Exter. Plating Sn	7440-31-5			0.000710	1000000	19767.3709531		
<b>External Plating Total:</b>						<b>0.000710</b>	<b>1000000</b>	<b>19767.3709531</b>
Inter. Plating Ni	7440-02-0			0.000000	0	0		
Inter. Plating Ag	7440-22-4			0.000086	1000000	2394.27441406		
<b>Internal Plating Total:</b>						<b>0.000086</b>	<b>1000000</b>	<b>2394.27441406</b>
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000518	750000	14421.3267119		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000173	250000	4816.38867188		
		<b>Die Attach Total:</b>				<b>0.000691</b>	<b>1000000</b>	<b>19237.7148438</b>
		Encapsulation	MULTIAROMATIC RESIN BOND FREE	Resin (EP)		0.002439	130000	67902.7266625
Bromine (Br)	40093-93-8			0.000000	0	0		
Silica (SiO2)	60676-86-0			0.015571	830000	431502.84375		
Antimony Trioxide (Sb2O3)	1309-64-4			0.000000	0	0		
Metal Hydroxide				0.000657	35000	18291.1425781		
Carbon Black (C)	1333-86-4			0.000094	5000	2616.99755859		
<b>Encapsulation Total:</b>						<b>0.018761</b>	<b>1000000</b>	<b>522313.71875</b>
Bond Wire Estimated	AFW/TANAKA/Kn			Gold (Au)	7440-57-5	0.000179	1000000	4983.43115234

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